

PATENT
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Application Number(s) or Patent Number(s) Additional numbers attached? Yes No XX

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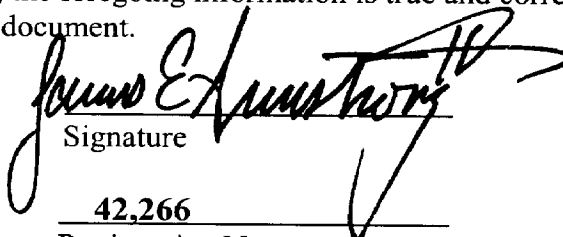
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Statement and signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

James E. Armstrong IV

Name of Person Signing



Signature

July 30, 2003

Date

42,266

Registration No.

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U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by
**FUJITSU LIMITED of 1-1, Kamikodanaka 4-chome, Nakahara-ku, Kawasaki-shi,
Kanagawa 211-8588 Japan**

(Insert ASSIGNEE's
Name(s) Address(es))

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of Invention)

**RESIST PATTERN THICKENING MATERIAL, PROCESS FOR FORMING
RESIST PATTERN, AND PROCESS FOR MANUFACTURING SEMICONDUCTOR
DEVICE**

(*If the assignment is
being filed after the
filing of the
application, this
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for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

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(ARMSTRONG, WESTERMAN & HATTORI, LLP is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefore on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

<u>Miwa Kozawa</u> (Signature)	<u>Miwa Kozawa</u> (Type Name)	<u>July 8, 2003</u> (Date)
<u>Koji Nozaki</u> (Signature)	<u>Koji Nozaki</u> (Type Name)	<u>July 8, 2003</u> (Date)
<u>Takahisa Namiki</u> (Signature)	<u>Takahisa Namiki</u> (Type Name)	<u>July 8, 2003</u> (Date)
<u>Junichi Kon</u> (Signature)	<u>Junichi Kon</u> (Type Name)	<u>July 8, 2003</u> (Date)
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_____ (Signature)	_____ (Type Name)	_____ (Date)

NO LEGALIZATION REQUIRED